



CHENMKO ENTERPRISE CO.,LTD

SURFACE MOUNT

Dual N-Channel Enhancement MOS FET

VOLTAGE 60 Volts CURRENT 0.250 Ampere

2N7002S

APPLICATION

- * Servo motor control.
- * Power MOSFET gate drivers.
- * Other switching applications.

FEATURE

- * Small surface mounting type. (SC-88/SOT-363)
- * High density cell design for low $R_{DS(ON)}$.
- * Suitable for high packing density.
- * Rugged and reliable.
- * High saturation current capability.
- * Voltage controlled small signal switch.

CONSTRUCTION

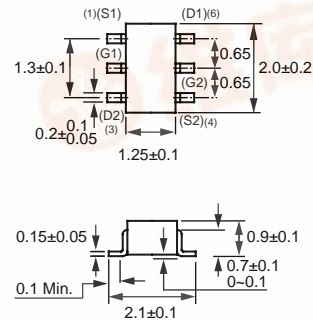
- * Dual N-Channel Enhancement

MARKING

- * 702S



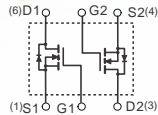
SC-88/SOT-363



Dimensions in millimeters

SC-88/SOT-363

CIRCUIT



Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	2N7002S	Units
V_{DSS}	Drain-Source Voltage	60	V
V_{DGR}	Drain-Gate Voltage ($R_{GS} \leq 1 \text{ M}\Omega$)	60	V
V_{GSS}	Gate-Source Voltage - Continuous - Non Repetitive ($t_p < 50\mu\text{s}$)	± 20	V
		± 40	
I_D	Maximum Drain Current - Continuous - Pulsed	$T_A = 25^\circ\text{C}$ 250	mA
		$T_A = 70^\circ\text{C}$ 190	
P_D	Maximum Power Dissipation	$T_A = 25^\circ\text{C}$ 350	mW
		$T_A = 70^\circ\text{C}$ 220	
$T_{J,STG}$	Operating and Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_L	Maximum Lead Temperature for Soldering Purposes, 1/16" from Case for 10 Seconds	300	$^\circ\text{C}$

Thermal characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	450	$^\circ\text{C}/\text{W}$
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RATING CHARACTERISTIC CURVES (2N7002S)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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OFF CHARACTERISTICS

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 10\ \mu\text{A}$	60	70		V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$			1	μA
		$T_C = 125^\circ\text{C}$			0.5	mA
I_{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 15\text{ V}, V_{DS} = 0\text{ V}$			10	nA
I_{GSSR}	Gate - Body Leakage, Reverse	$V_{GS} = -15\text{ V}, V_{DS} = 0\text{ V}$			-10	nA

ON CHARACTERISTICS (Note 1)

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	1	2.0	2.5	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 250\text{ mA}$		1.7	3.0	Ω
		$V_{GS} = 4.0\text{ V}, I_D = 100\text{ mA}$		2.5	4.0	
$V_{DS(on)}$	Drain-Source On-Voltage	$V_{GS} = 10\text{ V}, I_D = 500\text{ mA}$		0.6	3.75	V
		$V_{GS} = 5.0\text{ V}, I_D = 50\text{ mA}$		0.09	1.5	
$I_{D(on)}$	On-State Drain Current	$V_{GS} = 10\text{ V}, V_{DS} = 7.5V_{DS(on)}$	800	1300		mA
		$V_{GS} = 4.5\text{ V}, V_{DS} = 10V_{DS(on)}$	500	700		
g_{FS}	Forward Transconductance	$V_{DS} = 15\ V_{DS(on)}, I_D = 200\text{ mA}$		250		mS

DYNAMIC CHARACTERISTICS

Q_g	Total Gate Charge	$V_{DS} = 30\text{ V}, V_{GS} = 10\text{ V},$ $I_D = 250\text{ mA}$		0.6	1.0	nC
Q_{GS}	Gate-Source Charge			0.06	25	
Q_{GD}	Gate-Drain Charge			0.06	5	
C_{iss}	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$		25	50	pF
C_{oss}	Output Capacitance			6	25	
C_{rss}	Reverse Transfer Capacitance			1.2	5	
t_{on}	Turn-On Time	$V_{DD} = 30\text{ V}, R_L = 200\ \Omega,$ $I_D = 100\text{ mA}, V_{GS} = 10\text{ V},$ $R_{GEN} = 10\ \Omega$		7.5	20	nS
t_r				6		
t_{off}	Turn-Off Time	$V_{DD} = 30\text{ V}, R_L = 200\ \Omega,$ $I_D = 100\text{ mA}, V_{GS} = 10\text{ V},$ $R_{GEN} = 10\ \Omega$		7.5	20	nS
t_f				3		

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I_S	Maximum Continuous Drain-Source Diode Forward Current			115	mA	
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current			0.8	A	
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 200\text{ mA}$ (Note 1)		0.85	1.2	V

Note:

1. Pulse Test: Pulse Width < 300 μs , Duty Cycle < 2.0%.

RATING CHARACTERISTIC CURVES (2N7002S)

Typical Electrical Characteristics

Figure 1. On-Region Characteristics

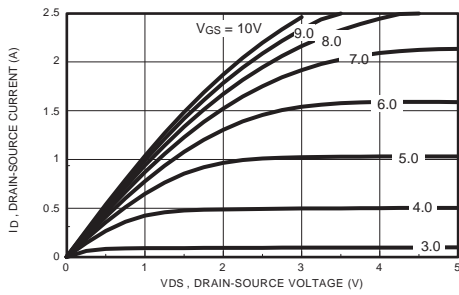


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current

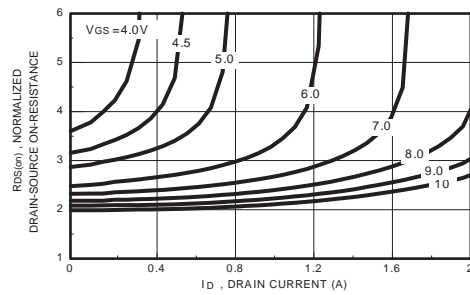


Figure 3. On-Resistance Variation with Temperature

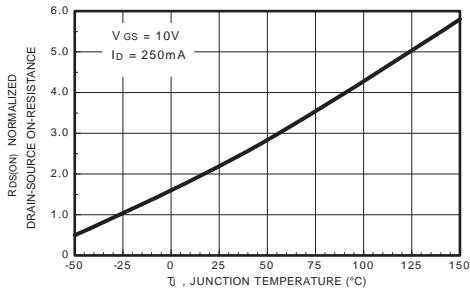


Figure 4. On-Resistance Variation with Drain Current and Temperature

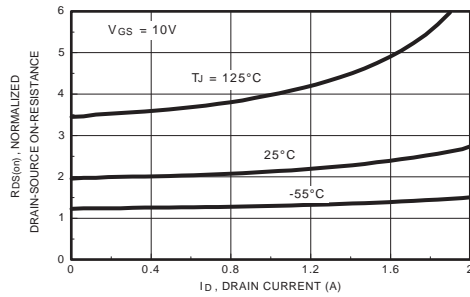


Figure 5. Transfer Characteristics

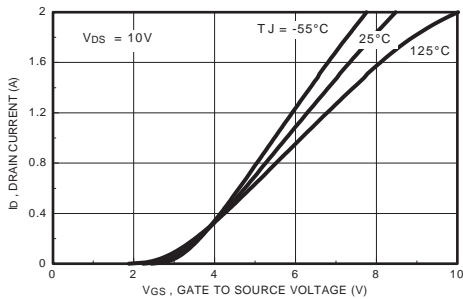
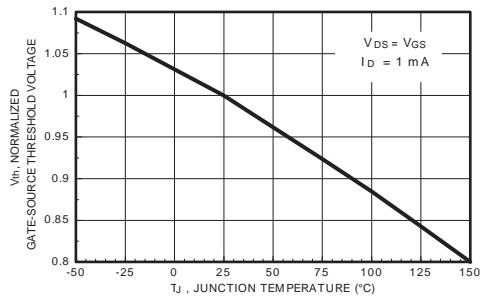


Figure 6. Gate Threshold Variation with Temperature



RATING CHARACTERISTIC CURVES (2N7002S)

Typical Electrical Characteristics (continued)

Figure 7. Breakdown Voltage Variation with Temperature

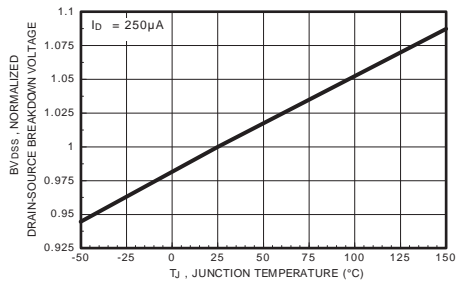


Figure 8. Body Diode Forward Voltage Variation with Drain Current

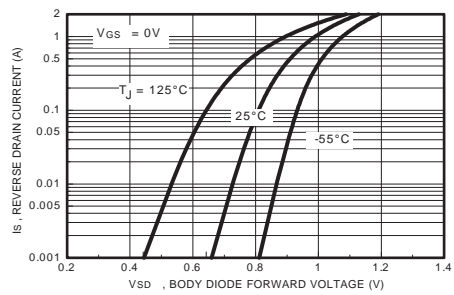


Figure 9. Capacitance Characteristics

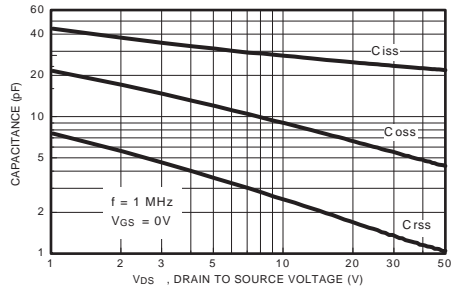


Figure 10. Gate Charge Characteristics

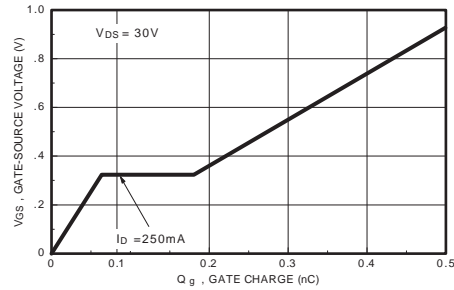


Figure 11.

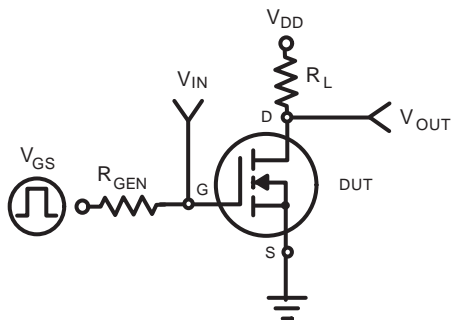
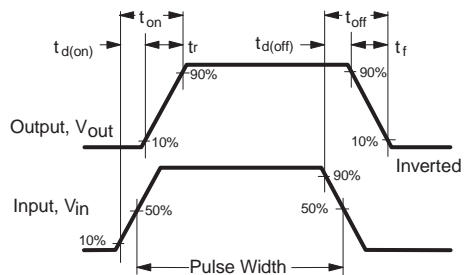


Figure 12. Switching Waveforms



RATING CHARACTERISTIC CURVES (2N7002S)

Typical Electrical Characteristics (continued)

Figure 13. 2N7002S Maximum Safe Operating Area

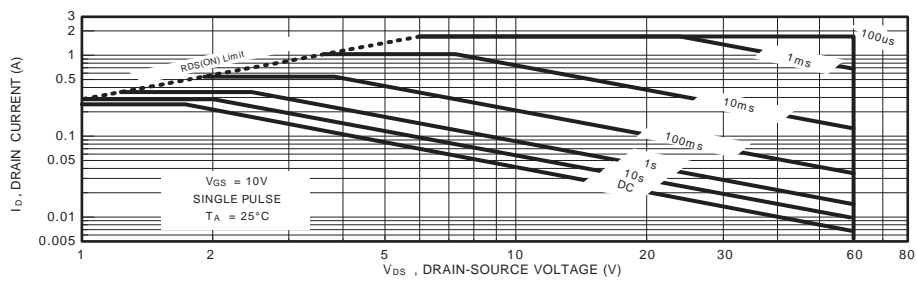


Figure 14. 2N7002S Transient Thermal Response Curve

